

American Thermal Products

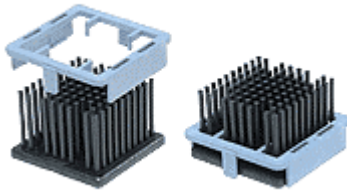
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MBA37.5002 Series

BGA Heatsink for 37.5 x 37.5 mm Chipset



:: Specification ::

Heat Sink							
Material	Heat Sink	AL6063					
	Embedded Base						
Dimension	37.5 x 37.5 mm (L x W)						
	Part No.	H	F.S.	Base	Clip	W	Rth(°C/W)
	MBA37.5002-	12	P	/2.6	-Y,BU,O	15.7 g	3.22
	MBA37.5002-	15	P	/2.6	-Y,BU,O	17.8 g	2.68
	MBA37.5002-	20	P	/2.6	-Y,BU,O	21.3 g	1.91
	MBA37.5002-	25	P	/2.6	-Y,BU,O	24.8 g	1.57
Technology	Precision Forging						
Finish	Black or Nature anodize						
Clip							
Material	Plastic (UL94-V0)						
Melting Point	N/A						
Note	Clip available : Chipset thickness • 3.0 ~ 3.6 mm Y - Yellow colored clip • 1.4 ~ 2.0 mm BU - Blue colored clip • 0.5 ~ 1.1 mm O - Orange colored clip						

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